



Continental Device India Pvt. Limited

An IATF 16949, ISO9001 and ISO 14001/ISO 45001 Certified Company



PNP SILICON PLANAR SWITCHING TRANSISTORS

2N2906A
2N2907A



TO-18

TO-18
Metal Can Package
RoHS compliant

FEATURE:

1. This product is available in AEC-Q101 Compliant and PPAP Capable also.

Note: For AEC-Q101 compliant products, please use suffix -AQ in the part number while ordering.

APPLICATION: Switching And Linear Application DC to VHF Amplifier Applications

ABSOLUTE MAXIMUM RATINGS (Ta = 25 °C Unless otherwise specified)

PARAMETER	SYMBOL	VALUE		UNIT
		2N2906A	2N2907A	
Collector -Emitter Voltage	V_{CEO}	60		V
Collector -Base Voltage	V_{CBO}	60		V
Emitter -Base Voltage	V_{EBO}	5.0		V
Collector Current Continuous	I_C	600		mA
Power Dissipation @Ta=25°C	P_D	400		mW
Derate Above 25°C	P_D	2.28		mW/°C
@ Tc=25°C		1.8		W
Derate Above 25°C		10.3		mW/°C
Operating And Storage Junction Temperature Range	T_j, T_{stg}	-65 to +200		°C

ELECTRICAL CHARACTERISTICS at (Ta = 25 °C Unless otherwise specified)

PARAMETER	SYMBOL	TEST CONDITION	MIN	MAX	UNIT
Collector -Emitter Voltage	V_{CEO}^1	$I_C=10mA, I_B=0$	60	--	V
Collector -Base Voltage	V_{CBO}	$I_C=10\mu A, I_E=0$	60	--	V
Emitter-Base Voltage	V_{EBO}	$I_E=10\mu A, I_C=0$	5.0	--	V
Collector-Cut off Current	I_{CBO}	$V_{CB}=50V, I_E=0$	--	10	nA
		$V_{CB}=50V, I_E=0, T_a=150^\circ C$	--	10	μA
	I_{CEX}	$V_{CE}=30V, V_{BE}=0.5V$	--	50	nA
Base Current	I_B	$V_{CE}=30V, V_{BE}=0.5V$	--	50	nA
Collector Emitter Saturation Voltage	$V_{CE(Sat)}^1$	$I_C=150mA, I_B=15mA$	--	0.4	V
		$I_C=500mA, I_B=50mA$	--	1.6	V
Base Emitter Saturation Voltage	$V_{BE(Sat)}^1$	$I_C=150mA, I_B=15mA$	--	1.3	V
		$I_C=500mA, I_B=50mA$	--	2.6	V

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ELECTRICAL CHARACTERISTICS at (Ta = 25 °C Unless otherwise specified)

PARAMETER	SYMBOL	TEST CONDITION		2N2906A	2N2907A	UNIT
DC Current Gain	h _{FE}	I _C =0.1mA, V _{CE} =10V	MAX	40	75	
		I _C =1mA, V _{CE} =10V	MAX	40	100	
		I _C =10mA, V _{CE} =10V	MAX	40	100	
		I _C =150mA, V _{CE} =10V ⁻¹		40-120	100-300	
		I _C =500mA, V _{CE} =10V ⁻¹	MAX	40	50	

PARAMETER	SYMBOL	TEST CONDITION	MIN	MAX	UNIT
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DYNAMIC CHARACTERISTICS

Transition Frequency	f _t ²	I _C =50mA, V _{CE} =20V, f=100MHz	200	--	MHz
Out-Put Capacitance	C _{ob}	V _{CB} =10V, I _E =0, f=100kHz	--	8.0	pF
Input Capacitance	C _{ib}	V _{BE} =2V, I _C =0, f=100kHz	--	30.0	pF

Switching Time

Delay time	t _d	I _C =150mA, I _{B1} =15mA, V _{CC} =30V	--	10	ns
Rise time	t _r		--	40	
Turn-On Time	t _{on}		--	45	
Storage time	t _s	I _C =150mA, I _{B1} =I _{B2} =15mA, V _{CC} =6V	--	80	
Fall time	t _f		--	30	
Turn-Off Time	t _{off}		--	100	

Note:

1. Pulse Condition: Pulse Width=300us, Duty Cycle=2%
2. f_t is defined as the frequency at which |h_{fe}| extrapolates to unity
3. For PNP device voltage and current values will be negative (-).

Recommended Reflow Solder Profiles

The recommended reflow solder profiles for Pb and Pb-free devices are shown below.

Figure 1 shows the recommended solder profile for devices that have Pb-free terminal plating, and where a Pb-free solder is used.

Figure 2 shows the recommended solder profile for devices with Pb-free terminal plating used with leaded solder, or for devices with leaded terminal plating used with a leaded solder.

Figure 1

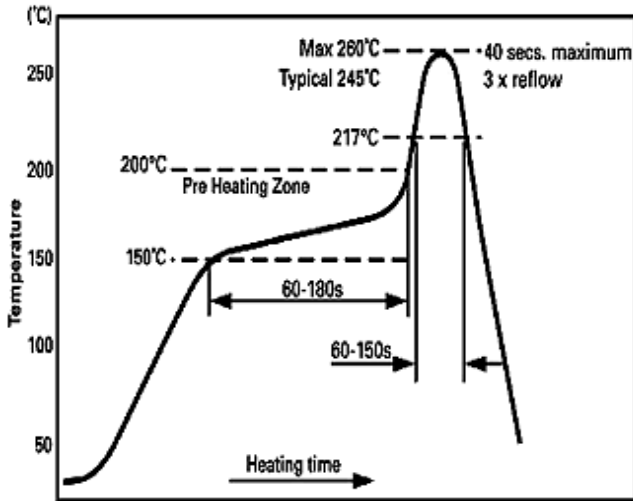
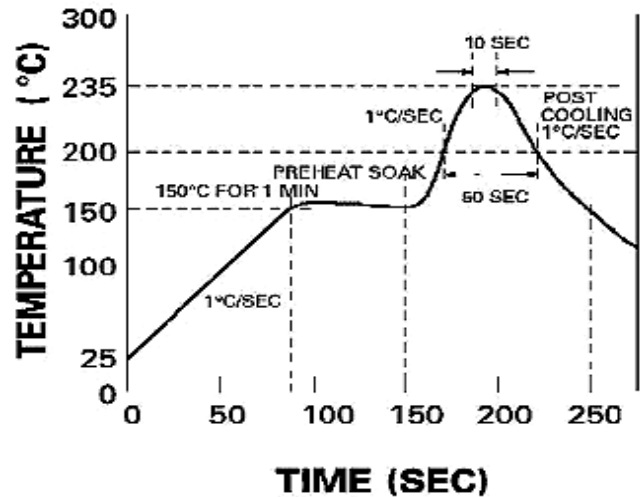


Figure 2



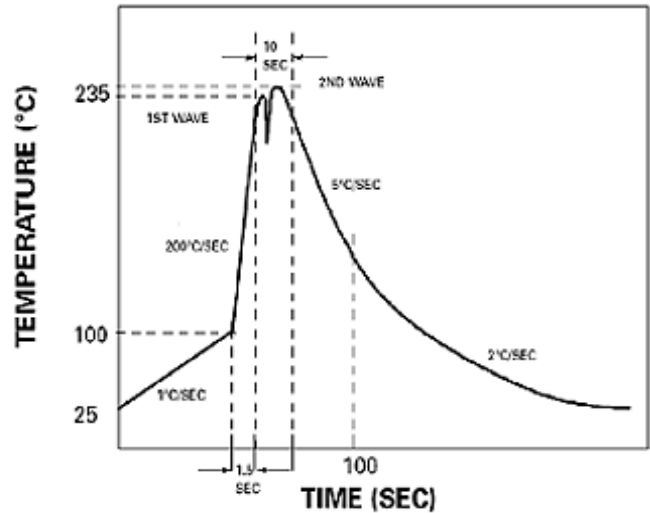
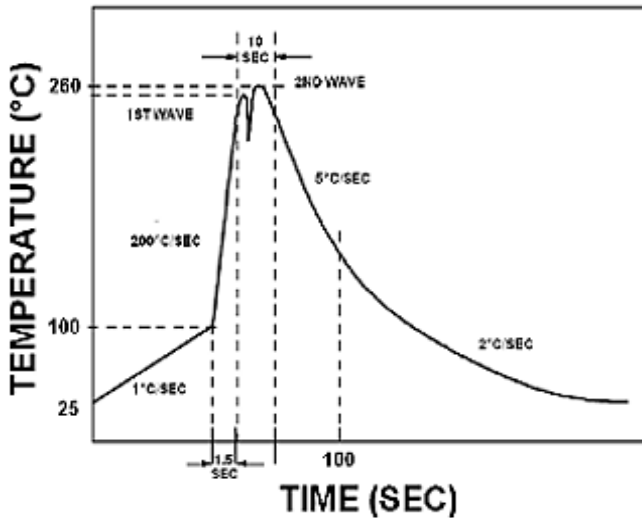
Reflow profiles in tabular form

Profile Feature	Sn-Pb System	Pb-Free System
Average Ramp-Up Rate	~3°C/second	~3°C/second
Preheat – Temperature Range – Time	150-170°C 60-180 seconds	150-200°C 60-180 seconds
Time maintained above: – Temperature – Time	200°C 30-50 seconds	217°C 60-150 seconds
Peak Temperature	235°C	260°C max.
Time within +0 -5°C of actual Peak	10 seconds	40 seconds
Ramp-Down Rate	3°C/second max.	6°C/second max.

Recommended Wave Solder Profiles

The Recommended solder Profile For Devices with Pb-free terminal plating where a Pb-free solder is used

The Recommended solder Profile For Devices with Pb-free terminal plating used with leaded solder, or for devices with leaded terminal plating used with leaded solder

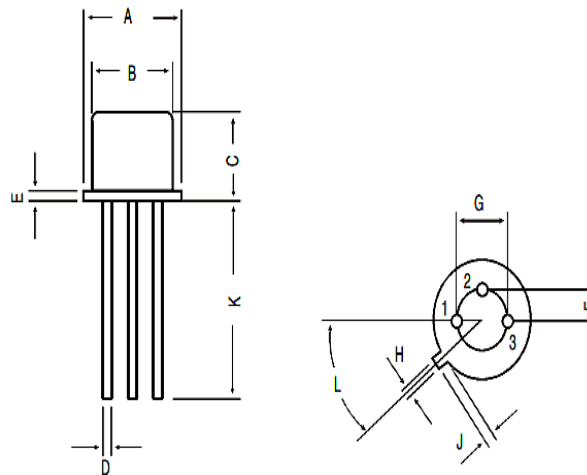


Wave Profiles in Tabular Form

Profile Feature	Sn-Pb System	Pb-Free System
Average Ramp-Up Rate	~200°C/second	~200°C/second
Heating rate during preheat	Typical 1-2, Max 4°C/sec	Typical 1-2, Max 4°C/Sec
Final preheat Temperature	Within 125°C of Solder Temp	Within 125°C of Solder Temp
Peak Temperature	235°C	260°C max.
Time within +0 -5°C of actual Peak	10 seconds	10 seconds
Ramp-Down Rate	5°C/second max.	5°C/second max

PACKAGE DETAILS

TO-18 Metal Can Package

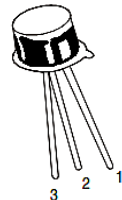


DIM	MIN	MAX
A	5.24	5.84
B	4.52	4.97
C	4.31	5.33
D	0.40	0.53
E	--	0.76
F	--	1.27
G	--	2.97
H	0.91	1.17
J	0.71	1.21
K	12.70	--
L	45°	

All dimensions are in mm

PIN CONFIGURATION

1. EMITTER
2. BASE
3. COLLECTOR



Packing Detail

PACKAGE	STANDARD PACK		INNER CARTON BOX		OUTER CARTON BOX		
	Details	Net Weight/Qty	Size	Qty	Size	Qty	Gr Wt
TO-18	1K/polybag	350 gm/1K pcs	3" x 7.5" x 7.5"	5.0K	17" x 15" x 13.5"	80.0K	34 kgs



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Recommended Product Storage Environment for Discrete Semiconductor Devices

This storage environment assumes that the Diodes and transistors are packed properly inside the original packing supplied by CDIL.

- Temperature 5 °C to 30 °C
- Humidity between 40 to 70 %RH
- Air should be clean.
- Avoid harmful gas or dust.
- Avoid outdoor exposure or storage in areas subject to rain or water spraying .
- Avoid storage in areas subject to corrosive gas or dust. Product shall not be stored in areas exposed to direct sunlight.
- Avoid rapid change of temperature.
- Avoid condensation.
- Mechanical stress such as vibration and impact shall be avoided.
- The product shall not be placed directly on the floor.
- The product shall be stored on a plane area. They should not be turned upside down. They should not be placed against the wall.

Shelf Life of CDIL Products

The shelf life of products is the period from product manufacture to shipment to customers. The product can be unconditionally shipped within this period. The period is defined as 2 years.

If products are stored longer than the shelf life of 2 years the products shall be subjected to quality check as per CDIL quality procedure.

The products are further warranted for another one year after the date of shipment subject to the above conditions in CDIL original packing.

Floor Life of CDIL Products and MSL Level

When the products are opened from the original packing, the floor life will start.

For this, the following JEDEC table may be referred:

JEDEC MSL Level		
Level	Time	Condition
1	Unlimited	≤30 °C / 85% RH
2	1 Year	≤30 °C / 60% RH
2a	4 Weeks	≤30 °C / 60% RH
3	168 Hours	≤30 °C / 60% RH
4	72 Hours	≤30 °C / 60% RH
5	48 Hours	≤30 °C / 60% RH
5a	24 Hours	≤30 °C / 60% RH
6	Time on Label(TOL)	≤30 °C / 60% RH



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Customer Notes

Component Disposal Instructions

1. CDIL Semiconductor Devices are RoHS compliant, customers are requested to please dispose as per prevailing Environmental Legislation of their Country.
2. In Europe, please dispose as per EU Directive 2002/96/EC on Waste Electrical and Electronic Equipment (WEEE).

Disclaimer

The product information and the selection guides facilitate selection of the CDIL's Semiconductor Device(s) best suited for application in your product(s) as per your requirement. It is recommended that you completely review our Data Sheet(s) so as to confirm that the Device(s) meet functionality parameters for your application. The information furnished in the Data Sheet and on the CDIL Web Site/CD are believed to be accurate and reliable. CDIL however, does not assume responsibility for inaccuracies or incomplete information. Furthermore, CDIL does not assume liability whatsoever, arising out of the application or use of any CDIL product; neither does it convey any license under its patent rights nor rights of others. These products are not designed for use in life saving/support appliances or systems. CDIL customers selling these products (either as individual Semiconductor Devices or incorporated in their end products), in any life saving/support appliances or systems or applications do so at their own risk and CDIL will not be responsible for any damages resulting from such sale(s).

CDIL strives for continuous improvement and reserves the right to change the specifications of its products without prior notice.



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